IAP20 Rec'S PCT/PTO 29 MAR 2006.

APPLICATION DATA SHEET

Secrecy Order in Parent Appl.?::

Application information	
Application number::	
Filing Date::	·
Application Type::	Regular
Subject Matter::	Utility
Suggested classification::	
Suggested Group Art Unit::	
CD-ROM or CD-R?::	None
Number of CD disks::	
Number of copies of CDs::	
Sequence submission?::	
Computer Readable Form (CRF)?::	No
Number of copies of CRF::	
Title ::	METHOD FOR PREPARING DIELECTRIC
	PASTE FOR MULTI-LAYERED CERAMIC
	ELECTRONIC COMPONENT
Attorney Docket Number::	890050.539USPC
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	
Total Drawing Sheets::	
Small Entity?::	No
Petition included?::	No
Petition Type::	
Licensed U.S. Gov't Agency::	
Contract or Grant No::	

No

First Applicant Information

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Japan

Status::

Full Capacity

Given Name::

Shigeki

Middle Name::

Family Name::

Satou

Name Suffix::

City of Residence::

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State or Province of Residence::

Country of Residence::

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State or Province of mailing address::

Country of mailing address::

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Postal or Zip Code of mailing address::

103-8272

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Second Applicant Information

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Japan

Status::

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Correspondence Information

Correspondence Customer Number :: 00500

Representative Information

Representative Customer Number::		00500
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Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2004/014160	09/28/04

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2003-340399	09/30/03	Yes

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Assignee Information

Assignee name::	TDK Corporation
Street of mailing address::	1-13-1, Nihonbashi, Chuo-ku
City of mailing address::	Tokyo
State or Province of mailing address::	
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	103-8272

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